

Key Features



- 50 Ohm Impedance
- 1.0 ~ 3.0 GHz
- 1.1 dB Noise Figure
- 35.0 dBm Output IP₃
- 32.0 dB Gain
- +/-0.5 dB Gain Flatness
- 22.0 dBm P_{1dB}
- 1.5:1 VSWR
- Single DC Power Supply
- >34 Years MTBF
- Unconditional Stable
- RoHS Compliant

Product Description



WBA1030A is integrated with WanTcom proprietary low noise amplifier technology, high frequency micro electronic assembly techniques, and high reliability design to realize optimum low noise figure, wide bandwidth, high linearity, and unconditional stable performances together. With single DC voltage operation, the amplifier has optimal input and output matching in the specified frequency range at 50-Ohm impedance system. The amplifier has standard SMA connectorized WP-5 Gold plated housing.

The amplifier is designed to meet the rugged standard of MIL-STD-202g.

Applications

- Mobile Infrastructures
- GPS
- Astronomy
- Defense
- Security System
- Measurement
- Fixed Wireless



Specifications

Summary of the electrical specifications WBA1030A at room temperature

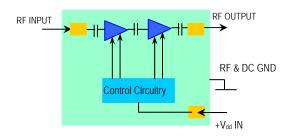
Index	Testing Item	Symbol	Test Constraints	Min	Nom	Max	Unit
1	Gain	S ₂₁	1.0 – 3.0 GHz	31	32		dB
2	Gain Variation	ΔG	1.0 – 3.0 GHz		+/- 0.5	+/-0.7	dB
3	Input VSWR	VSWR₁	1.0 – 3.0 GHz		1.22:1	1.5:1	Ratio
4	Output VSWR	VSWR ₂	1.0 – 3.0 GHz		1.5:1	1.8:1	Ratio
5	Reverse Isolation	S ₁₂	1.0 – 3.0 GHz	35	40		dB
6	Noise Figure	NF	1.0 – 3.0 GHz		1.1	1.3	dB
7	Output 1dB Gain Compression Point	P _{1dB}	1.0 – 3.0 GHz	20	22		dBm
8	Output Third Order Interception Point	IP ₃	Two-tone, P _{out} =+0 dBm each, 1 MHz sep.	30	35		dBm
9	Current Consumption	I _{dd}	V_{dd}		160		mA
10	DC Power Supply Voltage	V_{dd}		+4.7	+5	+5.3	V
11	Thermal Resistance, Junction to Case	R _{th,c}	Last stage transistor V _{ds} = 4.5V, I _{ds} = 110 mA,			125	°C/W
12	Operating Temperature	To		-40		+85	°C
13	Maximum Input CW RF Power	P _{IN, MAX}	DC – 6 GHz			10	dBm

Absolute Maximum Ratings

Parameters	Units	Ratings	
DC Power Supply Voltage	V	-0.5, +6V	
Drain Current	Α	0.2	
Total Power Dissipation	W	0.7	
Input CW RF Power	dBm	10	
Junction Temperature	°C	170	
Storage Temperature	°C	-55 ~ 125	
Operating Temperature	°C	-40 ~ 85	
Thermal Resistance	°C/W	125	

Operation of this device above any one of these parameters may cause permanent damage.

Functional Block Diagram

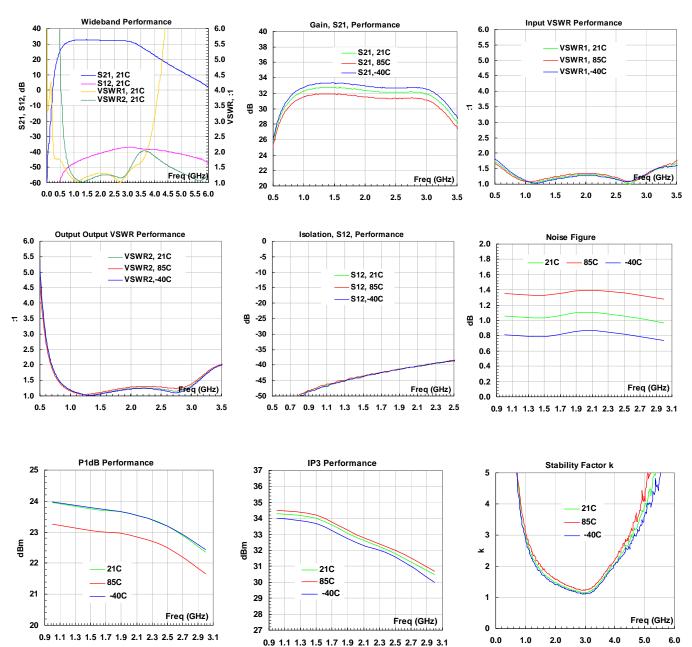


Ordering Information

	14/D 4 4000 4
l Model	WBA1030A

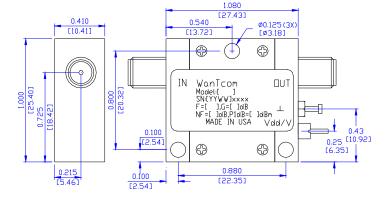
Additional heat sink is required for continuous operation!

Typical Data



Outline, WP-5 Housing

UNITS: INCH
[mm]
BODY: Brass
Finish: Gold Plating
RF Connector: SMA F Gold
V_{dd} PWR: Feed through



Application Notes:

A. SMA Torque Wrench Selection

Always use a torque wrench with $5 \sim 6$ inch-lb coupling torque setting for mating the SMA cables to the amplifier. Never use torque more than 8 inch-lb wrench for tightening the mating cable to the connectors. Otherwise, the permanent damage will occur to the SMA connectors of the amplifier. 8710-1582 (5 inch-lb) is one of the ideal torque wrench choice from Agilent Technology.

B. DC Power Line Connection

Strip the insulation layer at the end of DC power supply wire. The stripped length should be around 0.100" to 0.200". The 24 ~ 26 American Wire Gauge wire is suitable. Wound the stripped wire about 3/4 to 1 turn on the DC feed thru center pin. Solder the wounded wire and the center pin together. Clean the soldering joint by a Q-tip with alcohol to remove the flux and residue.

Do not use large soldering iron tip with more than 750 degree Fahrenheit to solder the wire and feed thru pin. Damage may occur to the feed thru. 0.010" size tip with 750 degree Fahrenheit temperature setting is suitable for the soldering works.

Repeat the process to solder the DC return wire on the ground turret. Higher temperature and larger tip can be used for this ground soldering.

C. Mounting the Amplifier

Use three pieces of #4-40 with longer than 9/16" screws for mounting the amplifier on a metal-based chase. Flat and spring washers are needed to prevent the screw loosening during the shock and vibration. Always use the appropriate torque setting of the power screwdriver to mount them.

High thermal conductivity thermal film such as T-gon is needed between the bottom of the amplifier and the heat sink surface. Refer to AN-155 for heat sink design, http://wantcominc.com/engineering_tools.htm.
